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Hogye 1-dong, Dongan-gu, Anyang-si, Gyeonggi-do 431-749 (KR).

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(74) Agents: LEE, Sang-Yong et al.; 4F., Byukcheon Bldg., 1597-5, Seocho-dong, Seocho-gu, Seoul 137-876 (KR).

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(71) Applicant (for all designated States except US): LG CABLE LTD. [KR/KR]; 19-20F ASEM Tower 159 Samsungdong, Gangnam-gu, Seoul 135-090 (KR).

(72) Inventors; and

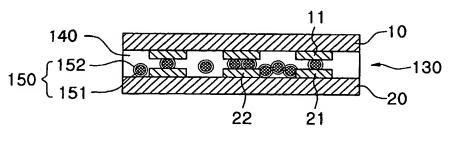
(75) Inventors/Applicants (for US only): BYUN, Jung-II [KR/KR]; LG Research Institute, Hogye 1-dong, Dongan-gu, Anyang-si, Gyeonggi-do 431-749 (KR). LEE, Kyung-Jun [KR/KR]; LG Research Institute, Hogye 1-dong, Dongan-gu, Anyang-si, Gyeonggi-do 431-749 (KR). JUNG, Jae-Yong [KR/KR]; LG Research Institute,

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(54) Title: ANISOTROPIC-ELECTROCONDUCTIVE ADHESIVE, CIRCUIT CONNECTION METHOD AND STRUCTURE USING THE SAME



(57) Abstract: Disclosed is an anisotropic-electroconductive adhesive, which includes insulating adhesive component containing a radical polymerizable compound a polymerization initiator; and a plurality of insulating coated electroconductive particles dispersed in the insulating adhesive component,

insulating coated electroconductive particle having a coating layer made of insulating thermoplastic resin on a surface of an electroconductive particle, wherein a softening point of the insulating thermoplastic resin is lower than an exothermic peak temperature of the insulating adhesive component. The anisotropic-electroconductive adhesive enables rapid curing of the insulating adhesive component at a low temperature and is very useful for making a circuit connection structure since it may prevent a short of circuit without connection failure even when the electroconductive particles are condensed.

